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BLP8G05S-200; BLP8G05S-200G

Power LDMOS transistor

AMPLEON

Rev. 2 — 1 October 2015

Product data sheet

1. Product profile

1.1 General description

200 W LDMOS power transistor for base stations applications at frequencies from 400 MHz to 500 MHz.

Table 1. Typical performance

RF performance at T_{case} = 25 °C, I_{Da} = 2 mA in an application circuit.

Test signal	f	V _{DS}	P _{L(AV)}	G _p	η_D
	(MHz)	(V)	(W)	(dB)	(%)
CW	440	28	210	21	81

1.2 Features and benefits

- High efficiency
- Excellent ruggedness
- Excellent thermal stability
- Integrated ESD protection
- Easy power control
- Designed for ISM operation (400 MHz to 500 MHz)
- Input integration for simple board design
- Compliant to Directive 2002/95/EC, regarding Restriction of Hazardous Substances (RoHS)

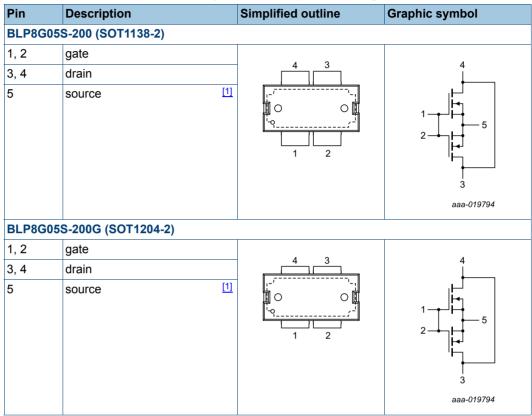
1.3 Applications

RF power amplifiers for W-CDMA base stations and multi carrier applications in the 400 MHz to 500 MHz frequency range

2. Pinning information

Table 2. Pinning

All pins must be connected for correct operation and to prevent damage to the device.



^[1] Connected to flange.

3. Ordering information

Table 3. Ordering information

Type number	Package	ackage			
	Name	Description	Version		
BLP8G05S-200	HSOP4F	plastic, heatsink small outline package; 4 leads (flat)	SOT1138-2		
BLP8G05S-200G	HSOP4	plastic, heatsink small outline package; 4 leads	SOT1204-2		

4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DS}	drain-source voltage		-	65	V
V_{GS}	gate-source voltage		-0.5	+13	V
T _{stg}	storage temperature		-65	+150	°C
T _{case}	case temperature		-	150	°C
Tj	junction temperature	[1]	-	225	°C

^[1] Continuous use at maximum temperature will affect the reliability.

5. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Тур	Unit
R _{th(j-case)}	thermal resistance from junction to case	T _{case} = 80 °C; P _L = 200 W	0.5	K/W

6. Characteristics

Table 6. DC characteristics

 T_i = 25 °C per section; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{(BR)DSS}	drain-source breakdown voltage	$V_{GS} = 0 \text{ V}; I_D = 3.2 \text{ mA}$	65	-	-	V
V _{GS(th)}	gate-source threshold voltage	V _{DS} = 10 V; I _D = 320 mA	1.5	1.9	2.3	V
I _{DSS}	drain leakage current	V _{GS} = 0 V; V _{DS} = 28 V	-	-	2.8	μА
I _{DSX}	drain cut-off current	$V_{GS} = V_{GS(th)} + 3.75 \text{ V};$ $V_{DS} = 10 \text{ V}$	-	52	-	Α
I _{GSS}	gate leakage current	V _{GS} = 11 V; V _{DS} = 0 V	-	-	280	nA
9 _{fs}	forward transconductance	V _{DS} = 10 V; I _D = 11.2 A	-	20	-	S
R _{DS(on)}	drain-source on-state resistance	$V_{GS} = V_{GS(th)} + 3.75 \text{ V};$ $I_D = 11.2 \text{ A}$	-	80.0	-	Ω

Table 7. RF characteristics

Test signal: CW at 440 MHz; RF performance at V_{DS} = 28 V; I_{Dq} = 2 mA; T_{case} = 25 °C; unless otherwise specified; in a class-AB production test circuit.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Gp	power gain	P _L = 210 W	19.5	21	-	dB
RLin	input return loss	P _L = 210 W	-	-15	-11	dB
η_{D}	drain efficiency	P _L = 210 W	73	77	-	%

7. Test information

7.1 Ruggedness in class-AB operation

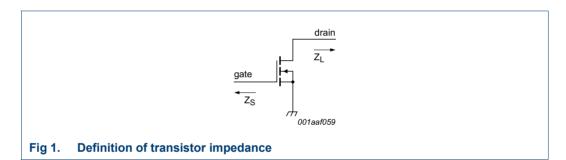
The BLP8G05S-200 and BLP8G05S-200G are capable of withstanding a load mismatch corresponding to VSWR = 10 : 1 through all phases under the following conditions: $V_{DS} = 28 \text{ V}$; $I_{Dq} = 20 \text{ mA}$; $P_L = 200 \text{ W}$ (CW); f = 440 MHz.

7.2 Impedance information

Table 8. Typical impedance

Measured load-pull data. Typical values unless otherwise specified. I_{Dq} = 20 mA; V_{DS} = 28 V. Z_S and Z_L defined in Figure 1.

f	Z _S	Z_L
(MHz)	(Ω)	(Ω)
440	1.5 + j0.7	1.1 + j0.14



7.3 Test circuit

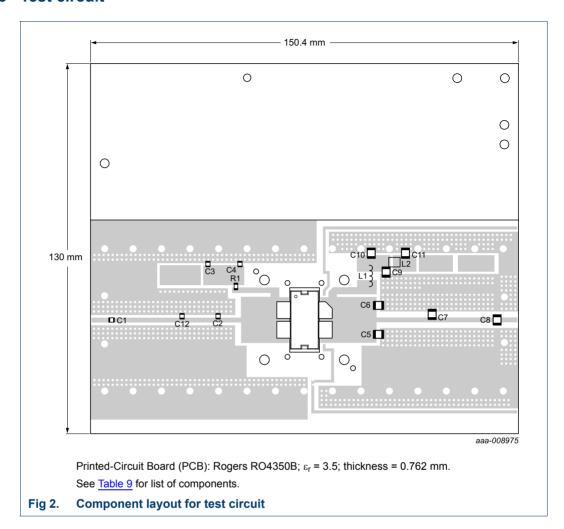
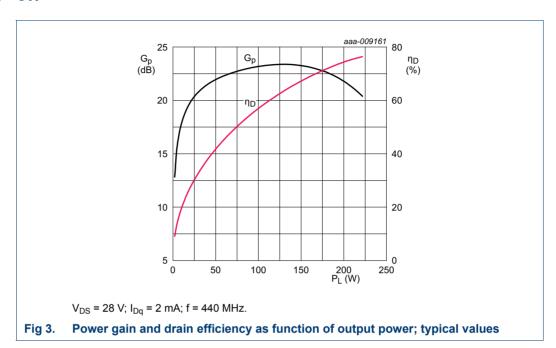


Table 9. List of components For test circuit, see Figure 2.

Component	Description	Value	Remarks
C1, C3	multilayer ceramic chip capacitor	160 pF	ATC800A
C2	multilayer ceramic chip capacitor	39 pF	ATC800A
C4, C9	multilayer ceramic chip capacitor	910 pF	ATC800B
C5, C6	multilayer ceramic chip capacitor	33 pF	ATC800B
C7	multilayer ceramic chip capacitor	15 pF	ATC800B
C8, C10	multilayer ceramic chip capacitor	130 pF	ATC800B
C11	electrolytic capacitor	220 μF, 63 V	
C12	multilayer ceramic chip capacitor	4.3 pF	ATC800A
R1	chip resistor	10 Ω	Philips: SMD 1206
L1	copper wire	6 turns	
L2	copper foil	-	

7.4 Graphical data

7.4.1 CW



8. Package outline

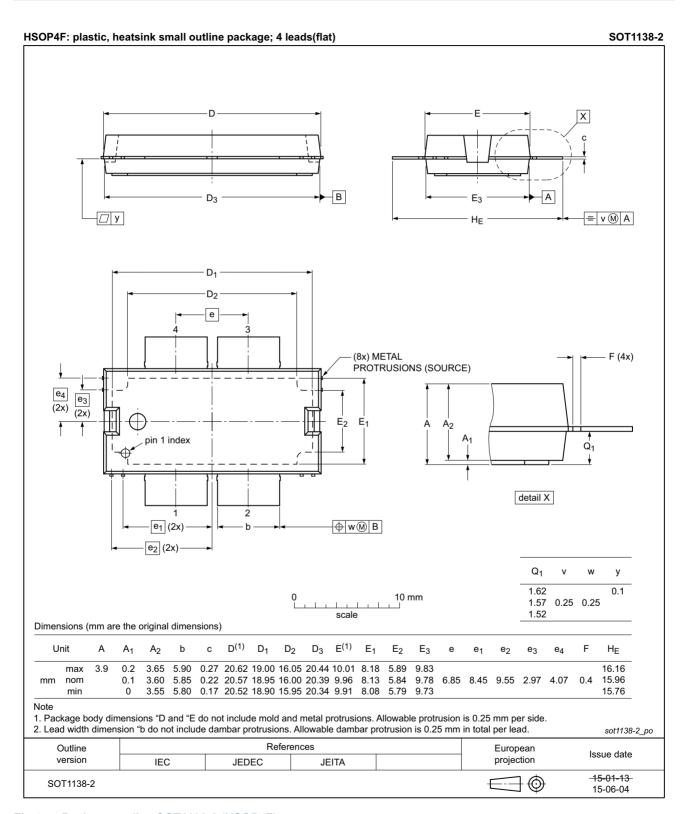


Fig 4. Package outline SOT1138-2 (HSOP4F)

BLP8G05S-200_8G05S-200G

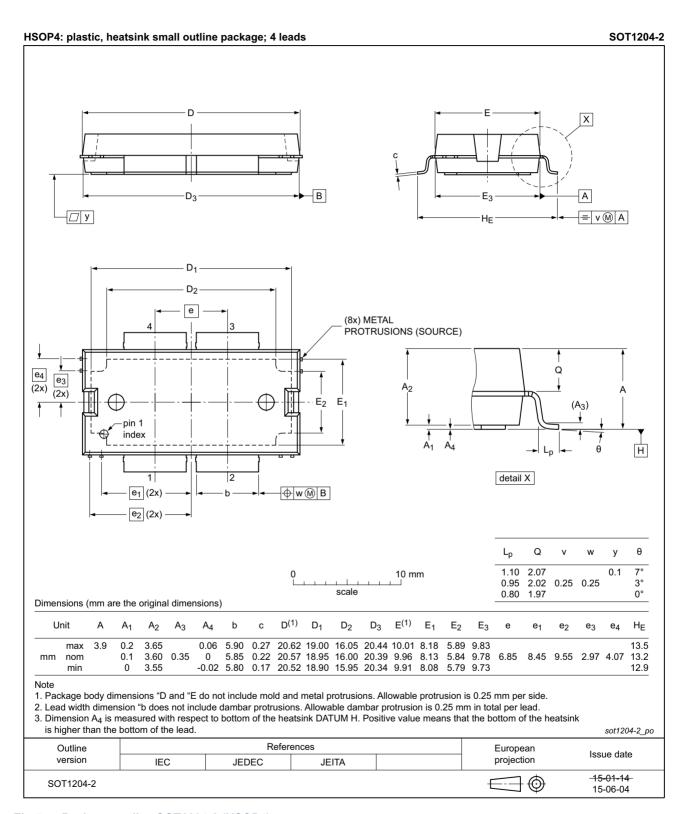


Fig 5. Package outline SOT1204-2 (HSOP4)

BLP8G05S-200_8G05S-200G

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9. Handling information

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the ANSI/ESD S20.20, IEC/ST 61340-5, JESD625-A or equivalent standards.

10. Abbreviations

Table 10. Abbreviations

Acronym	Description
CW	Continuous Wave
ESD	ElectroStatic Discharge
ISM	Industrial, Scientific and Medical
LDMOS	Laterally Diffused Metal-Oxide Semiconductor
SMD	Surface Mounted Device
VSWR	Voltage Standing-Wave Ratio
W-CDMA	Wideband Code Division Multiple Access

11. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
BLP8G05S-200_8G05S-200G v.2	20151001	Product data sheet	-	BLP8G05S-200_ 8G05S-200G v.1	
Modifications:	The format of this document has been redesigned to comply with the new identity guidelines of Ampleon				
	Legal texts have been adapted to the new company name where appropriate				
BLP8G05S-200_8G05S-200G v.1	20150917	Product data sheet	-	-	

12. Legal information

12.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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